



## Course Syllabus: Integrated Sensors - EE 310

<b>Division</b>	Computer, Electrical and Mathematical Sciences & Engineering
<b>Course Number</b>	EE 310
<b>Course Title</b>	Integrated Sensors
<b>Academic Semester</b>	Summer
<b>Academic Year</b>	2018/2019
<b>Semester Start Date</b>	06/16/2019
<b>Semester End Date</b>	08/08/2019
<b>Class Schedule</b> (Days & Time)	09:00 AM - 12:00 PM   Tue Wed

Instructor(s)				
Name	Email	Phone	Office Location	Office Hours
Khaled Nabil Salama	khaled.salama@kaust.edu.sa	+966128084420	3277, 3, Ibn Sina (bldg. 3)	Sunday 9am
Jurgen Kosel	jurgen.kosel@kaust.edu.sa	+966128084360	3219, 3, Ibn Sina (bldg. 3)	Sun 9am

Teaching Assistant(s)	
Name	Email

Course Information	
<b>Comprehensive Course Description</b>	We will present the design and implementation of monolithic and hybrid sensors using integrated circuits, particularly in CMOS. We will begin by providing the definitions and performance metrics of sensors. Subsequently, we will discuss the advantages and shortcomings of sensors built in silicon-based fabrication processes and examine, in detail, their integrated circuit topologies. Next, we will provide a comprehensive study of the design and analysis of CMOS integrated image sensors, integrated biosensors, and electronic backbone of MEMS hybrid sensors including silicon photodetectors; CCD and CMOS sensor architectures and circuits; affinity-based detection and biochemical transduction, integrated microarrays, biochips, and sensor SoCs.
<b>Course Description from Program Guide</b>	The design and implementation of monolithic and hybrid sensors using integrated circuits, particularly in CMOS is presented. Performance metrics of sensors will be defined. The advantages and shortcomings of sensors built in silicon-based fabrication processes will be analyzed. A comprehensive study of the design and analysis of CMOS integrated image sensors, integrated biosensors, and electronic backbone of MEMS hybrid sensors including silicon photodetectors; CCD and CMOS sensor architectures and circuits; affinity-based detection and biochemical transduction, integrated microarrays, biochips, and sensor SoCs will be studied.
<b>Goals and Objectives</b>	1- The ability to compare various sensors 2- The ability to understand the operation of sensors 3- The ability to present their work to a wide audience
<b>Required Knowledge</b>	Basic Physics, material science and electrical engineering.
<b>Reference Texts</b>	1- lecture notes handed in class 2- Wikipedia pages for sensor project ideas 3- no text book
<b>Method of evaluation</b>	20.00% - Others - Please specify 80.00% - Quiz(zes)

<b>Nature of the assignments</b>	There are 4 quizzes during the semester and a lab
<b>Course Policies</b>	
<b>Additional Information</b>	

### Tentative Course Schedule

*(Time, topic/emphasis & resources)*

Week	Lectures	Topic
1	Tue 06/18/2019 Wed 06/19/2019	<b>Sensor fundamentals</b> <b>Sensor fundamentals</b> <b>Passive element</b> <b>Active elements</b>
2	Tue 06/25/2019 Wed 06/26/2019	<b>Noise Analysis</b> <b>Sensor Architecture (Voltage, current)</b> <b>Sensor Architecture ( sinusoidal, impedance)</b>
3	Tue 07/02/2019 Wed 07/03/2019	<b>Biosensors</b> <b>Biosensors</b> <b>Chemical sensors</b> <b>Chemical/gas sensors</b>
4	Tue 07/09/2019 Wed 07/10/2019	<b>MEMS sensors</b> <b>Magnetic sensors</b> <b>Image sensors</b> <b>Packaging and integration</b>
5	Tue 07/16/2019 Wed 07/17/2019	Final exam presentations
6	Tue 07/23/2019 Wed 07/24/2019	N/A
7	Tue 07/30/2019 Wed 07/31/2019	N/A
8	Tue 08/06/2019 Wed 08/07/2019	N/A

**Note**

The instructor reserves the right to make changes to this syllabus as necessary.